

File View Edit Tools Window Help

Drafts  
 Pending  
 Active  
 L38: (2041) (fingerprint near recognition) or (fingerprint near sensor)  
 L39: (253) 38 and (chip die flip-chip flip near chip) and substrate and open\$3  
 L40: (253) 38 and (chip die flip-chip flip near chip) and substrate and (open\$3 trench)  
 Failed  
 Saved  
 (946) fingerprint near recognition  
 (12) (fingerprint near recognition) and semiconductor and (flip adj chip flip-chip)  
 (12) (fingerprint near recognition) and (flip adj chip flip-chip)  
 (12) (fingerprint near recognition) and (flip near chip flip-chip)  
 (315) (fingerprint near recognition) and (flip near chip flip-chip chip die)  
 (73) (fingerprint near recognition) and (flip near chip flip-chip chip die) and substrat  
 (191) (fingerprint near recognition) and semiconductor  
 (1) "5862248".PN.  
 (1) "6088471".PN.  
 (1) "6330145".PN.  
 (1) "6512381".PN.  
 (1) "6512381".PN.  
 (0) "2002/0109137".PN.  
 (0) "2002/0109137".PN.  
 (0) "2002/0117694".PN.  
 (0) "2002/0109137".PN.  
 (0) "2002/0117694".PN.  
 (1) "6512381".PN.  
 (1144) fingerprint and semiconductor and substrate  
 (737) (fingerprint and semiconductor and substrate) and (chip flip-chip flip near chip  
 (399) ((fingerprint and semiconductor and substrate) and (chip flip-chip flip near chip

Browse Queue Clear

DBs USPAT:US-Pat Plurals

Default operator: OR Highlight all hit terms initially

38 and (chip die flip-chip flip near chip) and substrate and (open\$3 trench)

OR term OR term Image Text HTML

	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef
17	<input type="checkbox"/>	<input type="checkbox"/>	US 20040055155 A1	20040325	15	System for providing an open-cavity low profile encapsulated semiconductor	29/860	29/840; 29/841;
18	<input type="checkbox"/>	<input type="checkbox"/>	US 20040051753 A1	20040318	310	Method of identifying printing cartridge characteristics with capacitive sensors	347/19	
19	<input type="checkbox"/>	<input type="checkbox"/>	US 20040046995 A1	20040311	89	Interactive publication printer and binder	358/1.15	270/58.08; 358/1.18;
20	<input type="checkbox"/>	<input type="checkbox"/>	US 20040046977 A1	20040311	88	Combined printer and binder	358/1.8	270/58.08; 358/1.18
21	<input type="checkbox"/>	<input type="checkbox"/>	US 20040022444 A1	20040205	113	Authentication using a digital watermark	382/232	
22	<input type="checkbox"/>	<input type="checkbox"/>	US 20040020284 A1	20040205	12	Atomic force microscopy measurements of: 73/159 contact resistance and current-dependent		
23	<input type="checkbox"/>	<input type="checkbox"/>	US 20040016291 A1	20040129	12	Atomic force microscopy measurements of: 73/105 contact resistance and current-dependent		324/693; 73/862.68;
24	<input type="checkbox"/>	<input type="checkbox"/>	US 20040016286 A1	20040129	12	Atomic force microscopy measurements of: 73/9 contact resistance and current-dependent		73/104; 73/862.381
25	<input type="checkbox"/>	<input type="checkbox"/>	US 20040016285 A1	20040129	12	Atomic force microscopy measurements of: 73/9 contact resistance and current-dependent		73/105; 73/862.68
26	<input type="checkbox"/>	<input type="checkbox"/>	US 20040000585 A1	20040101	86	Methods and systems for object identification and interaction	235/383	
27	<input type="checkbox"/>	<input type="checkbox"/>	US 20030230704 A1	20031218	10	CMOS photodiode having reduced dark current and improved light sensitivity and	250/208.1	